

TPS92692 Boost and Boost-to-Battery LED Driver Evaluation Board

This user's guide describes the characteristics, operation, and use of the TPS92692 Boost and Boost-to-Battery Evaluation Module (EVM). A complete schematic diagram, printed-circuit board layouts, and bill of materials are included in this document.

Contents

1	Introd	oduction					
2	Desci	ription	3				
	2.1	Typical Applications	3				
	2.2	Features	3				
3	Conn	ector Description	4				
	3.1	J2, Low Brightness, Full Brightness, GND	4				
	3.2	Configuring for Boost or Boost-to-Battery (J1, J3)	4				
	3.3	J4, Fault Response Setting	5				
	3.4	J5, IADJ Input Select	5				
	3.5	PWM Dimming (J6, J7)	5				
	3.6	J8, Dither Modulation Setting	5				
	3.7	TP2, Soft Start	5				
	3.8	TP8, PWM	6				
	3.9	TP7, IADJ	6				
	3.10	TP6, IMON					
4	Boost	t LED Driver Electrical Performance Specifications	6				
5		t LED Driver Schematic					
6	Perfo	rmance Data and Typical Characteristic Curves	8				
	6.1	Efficiency	8				
	6.2	Line Regulation	9				
	6.3	Load Regulation	10				
	6.4	Temperature Characteristics	11				
	6.5	Analog Adjust Settings	11				
	6.6	Analog-to-PWM Dimming	11				
	6.7	Direct External PWM Dimming	12				
	6.8	Typical Waveforms	12				
	6.9	EMI	14				
7		Boost LED Driver Electrical Performance Specifications					
8		Boost LED Driver Schematic					
9	Perfo	rmance Data and Typical Characteristic Curves					
	9.1	Efficiency					
	9.2	Line Regulation					
	9.3	Load Regulation	18				
	9.4	Typical Waveforms					
10	TPS9	2692EVM-880 Assembly Drawing and PCB layout	19				
11	Bill of	Materials	21				
		List of Figures					
1	Conn	ection Diagram	4				
2	TPS9	2692EVM-880 Schematic: Configured as a Boost LED Driver	7				



3	Efficiency vs Input Voltage (Number of Series-Connected LEDs = 8)	8
4	Efficiency vs Input Voltage (Number of Series-Connected LEDs = 13)	8
5	Efficiency vs Input Voltage (Number of Series-Connected LEDs = 18)	8
6	Output LED Current vs Input Voltage (V _{IADJ} = 420 mV)	g
7	Output LED Current vs Input Voltage (V _{IADJ} = 1.26 V)	g
8	Output LED Current vs Input Voltage (V _{IADJ} = 2.1 V)	ç
9	Output LED Current vs LED String Configuration (V _{IADJ} = 420 mV)	10
10	Output LED Current vs LED String Configuration (V _{IADJ} = 1.26 V)	10
11	Output LED Current vs LED String Configuration (V _{IADJ} = 2.1 V)	10
12	LED Current vs Ambient Temperature (V _{IN} = 13 V, Number of LEDs in Series = 8)	11
13	LED Current vs DIM/PWM Voltage (V _{IADJ} = 1.49 V, Number of LEDs in Series = 13)	12
14	Normal Operation	12
15	Spread Spectrum Frequency Modulation	12
16	Startup Transient	12
17	Analog-to-PWM Dimming Transient	12
18	Direct PWM Dimming Transient	12
19	PWM Dimming Transient (Zoomed)	12
20	LED Open-Circuit Fault	13
21	LED Short-Circuit Fault	13
22	Conducted EMI Based on CISPR 25 Class 3 Limits (Dither Modulation Enabled)	
23	TPS92692EVM-880 Schematic: Configured as a Buck-Boost LED Driver	
24	Efficiency vs Input Voltage (Number of Series-Connected LEDs = 7)	17
25	Output LED Current vs Input Voltage (V _{IADJ} = 1.26 V)	
26	Output LED Current vs LED String Configuration (V _{IADJ} = 1.26 V)	
27	LED Short-Circuit Fault	18
28	LED Open-Circuit Fault	18
29	Assembly Drawing	
30	Top Layer and Top Overlay (Top View)	
31	Bottom Layer and Bottom Overlay (Bottom View)	20
	List of Tables	
1	TPS92692EVM-880 Boost Configuration Electrical Performance Specifications	6
2	TPS92692EVM-880 Buck-Boost Configuration Electrical Performance Specifications	
3		21

Trademarks

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www.ti.com Introduction

1 Introduction

The TPS92692EVM-880 evaluation module (EVM) helps designers evaluate the operation and performance of the TPS92692-Q1 and TPS92692: high-accuracy LED controllers designed for automotive lighting and general illumination applications. The TPS92692EVM-880 uses the TPS92692-Q1 (AEC Q100) device; however, for general illumination and other non-automotive applications, the TPS92692 is available in the same package and pin configuration and with identical performance characteristics. The TPS92692-Q1 device implements a fixed-frequency peak current mode control technique with programmable switching frequency, slope compensation, and startup timing. It incorporates a low offset rail-to-rail current sense amplifier that can directly measure LED current over an output voltage range of 0 V to 65 V. Additional features include wide input voltage range (4.5 V to 65 V), spread spectrum frequency modulation, analog-to-PWM translation circuit, direct PWM dimming capability, analog dimming capability, adjustable switching frequency, input undervoltage protection, output overvoltage protection, and switch cycle-by-cycle current limit. The controller can be used to implement a range of LED driver topologies including Boost, Buck-Boost (Boost-to-Battery), SEPIC, and Flyback, based on the output LED stack voltage.

2 Description

The TPS92692EVM-880 is a fully assembled and tested LED driver that can be configured as either a Boost or a Boost-to-Battery topology to power a single string of series-connected LEDs. High accuracy, closed-loop LED current regulation is achieved using a low-offset rail-to-rail current sense amplifier along with high-side current-sensing implementation. The DC LED current set point can be varied over a 15:1 ratio using the high-impedance analog adjust (IADJ) input. PWM dimming of LED current is achieved by directly modulating the DIM/PWM input pin with the desired duty cycle or by enabling the internal PWM generator circuit. The optional PDRV gate driver output can be used to drive an external P-Channel series MOSFET.

The TPS92692 and TPS92692-Q1 support continuous LED status checks through the current monitor (IMON) output. The device also includes an open-drain fault indicator output that indicates LED overcurrent, output overvoltage, and output undervoltage conditions.

2.1 Typical Applications

This converter design describes an application of the TPS92692-Q1 device as a Boost and Boost-to-Battery LED driver with the specifications described in Table 1. For applications with a different input voltage range or different output voltage range, refer to the TPS92692-Q1 data sheet (SLVSDD9).

2.2 Features

- Versatile LED driver capable of driving a string of 1 to 20 series-connected white LEDs
- Wide input voltage range of 4.5 V to 18 V
- Better than ±4% LED current regulation using a high-side current sense resistor
- Spread spectrum frequency modulation for improved EMI
- Internal analog voltage to PWM duty cycle generator for stand-alone dimming operation
- Supports Boost, Buck-Boost (Boost-to-Battery), SEPIC, and Flyback LED driver topologies



Connector Description www.ti.com

3 Connector Description

This section describes the connectors and test points on the EVM and how to properly connect, setup, and use the TPS92692EVM-880.

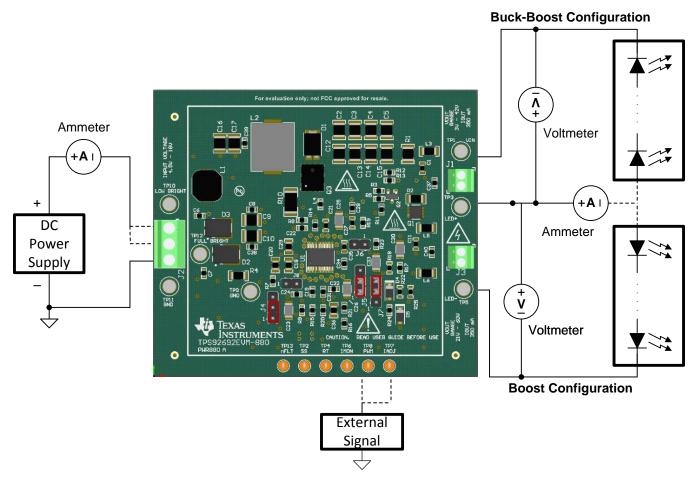


Figure 1. Connection Diagram

3.1 J2, Low Brightness, Full Brightness, GND

The 3-terminal screw-down connector, J2, is for connecting the EVM to the DC input voltage supply. To power the EVM, connect the positive terminal to pin 1 or pin 2 and the negative terminal to pin 3. The EVM can be configured to enter a low brightness state when power is applied to pin 1 and full brightness state when power is applied to pin 2. Other *Low Brightness* (TP10), *Full Brightness* (TP12), and GND (TP11) test points are provided on the board that can also be used for all purposes but input power.

3.2 Configuring for Boost or Boost-to-Battery (J1, J3)

The TPS92692EVM-880 can be configured as a boost regulator or a boost-to-battery regulator simply by connecting the LED load to either connector J1 or to connector J3 as described in this section. Do not attempt to use J1 and J3 simultaneously.

3.2.1 J1, LED+, VIN (Boost-to-Battery)

The screw-down connector, J1, marked LED+ and VIN is for connecting the LED load to the board in the Boost-to-Battery (Buck-Boost) configuration. The positive terminal for the LED load connects to LED+ while the negative terminal connects to VIN. The Boost-to-Battery design is for approximately 1 to 11 white LEDs.



www.ti.com Connector Description

3.2.2 J3, LED+, GND (Boost)

The screw-down connector, J3, marked LED+ and LED- is for connecting the LED load to the board in the Boost configuration. The Boost design is for approximately 7 to 18 white LEDs.

3.3 J4, Fault Response Setting

The three-pin header marked J4 is used to select between fault indication mode and internal timer based hiccup mode. The default setting is a shunt placed between pins 1 and 2 of J4. This connects the FLT pin to the SS pin and enables hiccup mode operation under output short-circuit conditions. To enable fault indication mode, switch the shunt location to short pins 2 and 3 of J4. This connects the FLT pin to the VREF pin via a resistance and sets the active-low fault status flag under fault conditions.

3.4 J5, IADJ Input Select

The three-pin header marked J5 is used to select the method of setting the LED current using the IADJ pin of the device. The default setting is a shunt placed between pins 1 and 2 of J5. This sets the IADJ voltage using a resistor divider from VREF for a constant LED current. External control of the LED current set point can be achieved by placing the shunt between pins 2 and 3 of J5 and applying a DC or PWM signal to the IADJ test point, TP7. Direct analog dimming can be implemented by removing the shunt and applying voltage directly to pin 2 of J5.

3.5 *PWM Dimming (J6, J7)*

PWM dimming of LED current is achieved by directly modulating the DIM/PWM input pin with the desired duty cycle or by enabling the internal PWM generator circuit.

3.5.1 Dimming Using Internal Analog-to-PWM Conversion Circuit

The two-pin header marked J6, in conjunction with the three-pin header marked J7, is used to enable the internal analog-to-PWM conversion circuit. By default, the ramp generator is enabled by removing the shunt across pins 1 and 2 of J6. The three-pin header marked J7 can be used to set the DIM/PWM input voltage. In the default setting, a shunt is placed between pins 2 and 3 of J7. In this configuration, 100% duty cycle (full brightness) is achieved by connecting the input power supply to pin 2 of connector J2 and a fixed 8% duty cycle (low brightness) is achieved by connecting the input power supply to pin 1 of connector J2. External control of the LED current duty cycle can be achieved by placing the shunt between pins 1 and 2 of J7 and applying an analog signal to the PWM test point, TP8.

3.5.2 Direct PWM Dimming

Direct external PWM dimming mode is set by placing the shunt across pins 1 and 2 of J6. This connects a 249-k Ω resistor and results in a constant 2.49-V reference voltage. In this mode, it is necessary to connect the shunt across pins 1 and 2 of J7 and apply a 5-V external PWM signal to PWM test point, TP8. The PWM dimming frequency can be set between 100 Hz and 1 kHz. Do not leave PWM test point, TP8, floating when operating in this configuration.

3.6 J8, Dither Modulation Setting

The two-pin header marked J8 is used to enable or disable spread-spectrum frequency modulation (dither modulation). By default, dither modulation is enabled by not having the shunt across pins 1 and 2 of J8. This connects the external capacitor to the DM pin of the device. Placing the shunt across pins 1 and 2 shorts the DM pin to GND and disables dither modulation.

3.7 TP2, Soft Start

The test point SS connects through a 1-k Ω resistor to the SS pin of the TPS92692-Q1 device. The voltage range is from 0 V to 5 V, if driven externally. The SS voltage can be monitored with this test point. Pulling SS to GND will also serve to disable the part and put it into STANDBY mode.



Connector Description www.ti.com

3.8 TP8, PWM

The PWM test point connects through J7 to the DIM/PWM pin of the TPS92692-Q1 device. An analog voltage or PWM signal can be applied to set the LED current duty cycle based on the dimming configuration.

3.9 TP7, IADJ

The IADJ test point connects through a two-pole low-pass filter to the IADJ pin of the TPS92692-Q1 device. The default reference is set to 1.49 V through a resistor divider network connected to VREF, resulting in an output current of 356 mA. The voltage on IADJ can be externally set using either a pulse-width modulated signal from a function generator or a DC power supply between 140 mV to over 2.4 V. For more details on setting analog adjust voltage refer to Section 6.5.

3.10 TP6, IMON

The IMON test point connects directly to the IMON pin of the TPS92692-Q1 device. The IMON voltage, corresponding to the measured LED current by the integrated rail-to-rail current sense amplifier, can be monitored with this test point. The pin can be connected to an external comparator or microcontroller to detect LED short-circuit, LED+ to VIN, and LED+ to GND fault conditions.

4 Boost LED Driver Electrical Performance Specifications

Table 1 provides the EVM Boost configuration electrical performance specifications.

Table 1. TPS92692EVM-880 Boost Configuration Electrical Performance Specifications

Parameter	Test Conditions	MIN	TYP	MAX	Unit
Input Characteristics				<u> </u>	
Input voltage range		7	14	18	V
Input UVLO setting			4.5		V
Maximum switch node voltage				100	V
Output Characteristics				"	
Output voltage, Vo	LED+ to LED-	21	40	60	V
LED current		100	350	500	mA
Maximum output power				25	W
Analog dimming range	V _{IADJ} = 140 mV to 2.1 V	15:1			
Internal RAMP generator frequency	Internal RAMP generator		240		Hz
Analog to PWM duty cycle set point (low brightness mode)			8		%
Analog to PWM duty cycle dimming range	1 ≤ V _{DIM} ≤ 3	4		100	%
Direct PWM dimming range	External PWM input signal, 100 ≤ f _{PWM} ≤ 1 kHz	1		100	%
Systems Characteristics				H-	
Output overvoltage protection threshold			62		V
Output overvoltage protection hysteresis			3		V
Soft-start period			8		ms
Dither modulation frequency			600		Hz
Switching frequency			390		kHz



Boost LED Driver Schematic www.ti.com

Boost LED Driver Schematic 5

Figure 2 illustrates the TPS92692EVM-880 schematic configured as a Boost LED driver.

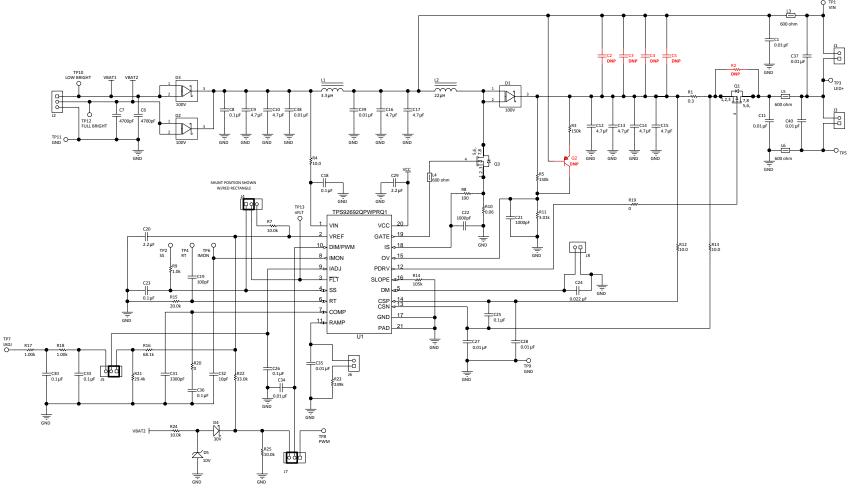


Figure 2. TPS92692EVM-880 Schematic: Configured as a Boost LED Driver



6 Performance Data and Typical Characteristic Curves

The following performance curves are presented for the EVM configured as a Boost LED driver (Figure 2).

6.1 Efficiency

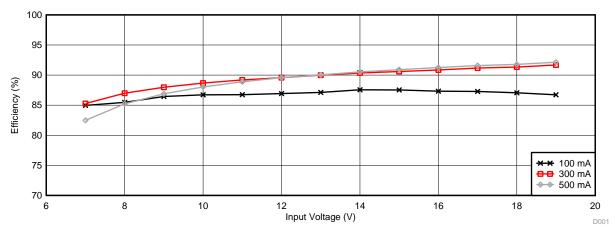


Figure 3. Efficiency vs Input Voltage (Number of Series-Connected LEDs = 8)

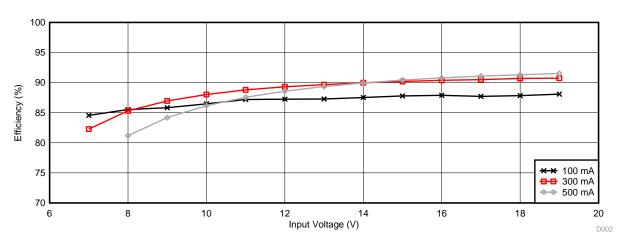


Figure 4. Efficiency vs Input Voltage (Number of Series-Connected LEDs = 13)

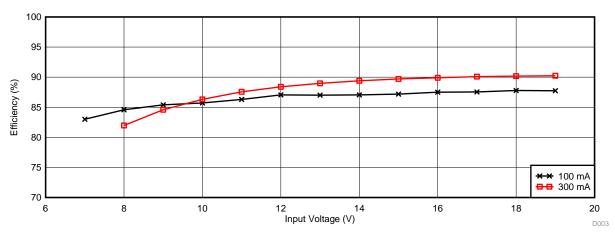


Figure 5. Efficiency vs Input Voltage (Number of Series-Connected LEDs = 18)



6.2 Line Regulation

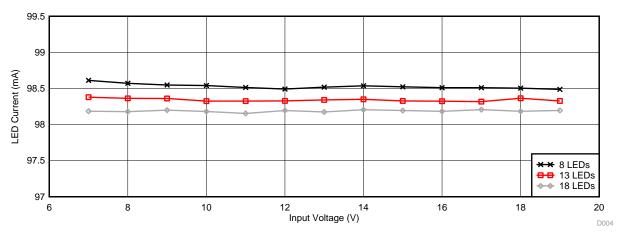


Figure 6. Output LED Current vs Input Voltage ($V_{IADJ} = 420 \text{ mV}$)

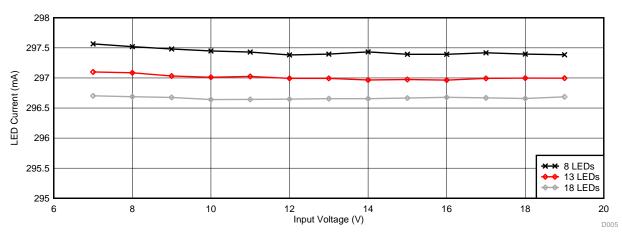


Figure 7. Output LED Current vs Input Voltage (V_{IADJ} = 1.26 V)

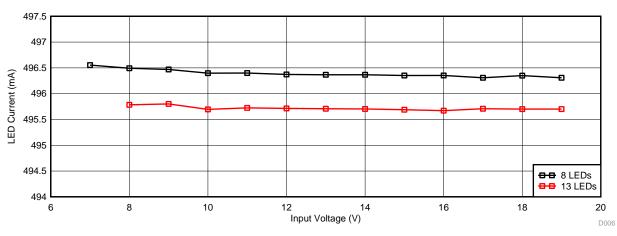


Figure 8. Output LED Current vs Input Voltage ($V_{IADJ} = 2.1 \text{ V}$)



6.3 Load Regulation

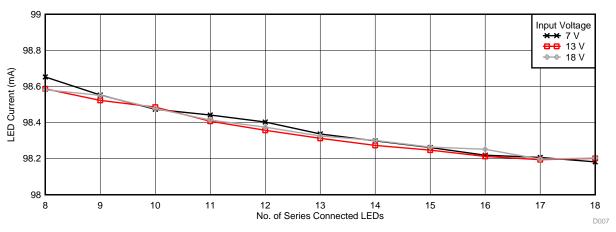


Figure 9. Output LED Current vs LED String Configuration (V_{IADJ} = 420 mV)

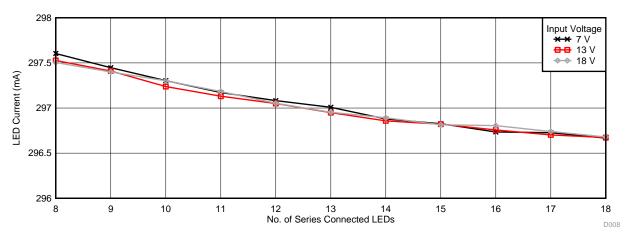


Figure 10. Output LED Current vs LED String Configuration ($V_{IADJ} = 1.26 \text{ V}$)

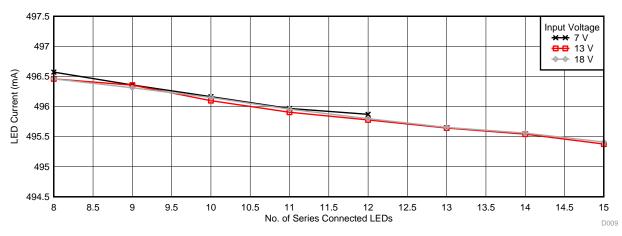


Figure 11. Output LED Current vs LED String Configuration ($V_{IADJ} = 2.1 \text{ V}$)



6.4 Temperature Characteristics

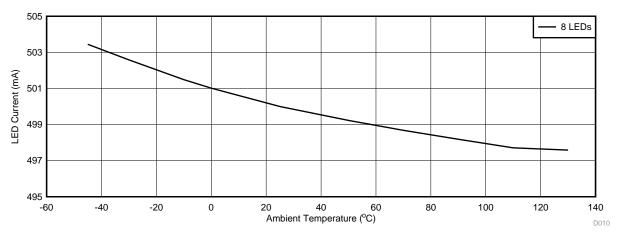


Figure 12. LED Current vs Ambient Temperature ($V_{IN} = 13 \text{ V}$, Number of LEDs in Series = 8)

6.5 Analog Adjust Settings

The EVM is configured with the IADJ voltage, V_{IADJ} , set to 1.49 V using resistor divider network, R16 and R21 between VREF and GND. The resulting LED current is 356 mA for a current sense resistor, $R_{CS} = R1$, of 300 m Ω . Calculation is based on:

$$I_{LED} = \frac{V_{IADJ}}{14} \frac{1}{R_{CS}}$$

The desired LED current can be achieved by setting the corresponding voltage, V_{IADJ} , and reconfiguring the resistor divider network, R16 and R21. The internal reference clamp of 2.4 V can be activated by depopulating resistor R21 and connecting IADJ to VREF through pullup resistor R16.

External control via the IADJ test point, TP7, can be enabled by changing the shunt position to connect pins 2 and 3 of J5. The IADJ voltage and hence the LED current can be modulated over the entire operating range by connecting a DC power supply or a function generator across TP7 to GND. To ensure proper operation and limit temperature rise, the maximum output power should be limited to 25 W for any given LED stack voltage and LED current combination.

6.6 Analog-to-PWM Dimming

The EVM can be configured for Analog-to-PWM dimming operation by removing the shunt across J6, which connects the capacitor from the RAMP pin to GND. The EVM can be configured to operate with a fixed-duty cycle of 8% by connecting a shunt across pins 2 and 3 of J7. In this case the V_{DIM} voltage is set by the resistor divider, R22 and R25, between VREF and GND. The low-brightness mode is activated when the input power is applied across pins 1 and 3 of J2.

External control, via the PWM test point, TP8, can be enabled by changing the shunt position to connect pins 1 and 2 of J7. The DIM/PWM voltage and hence the LED current duty cycle is modulated based on the voltage supplied by the external DC power supply.



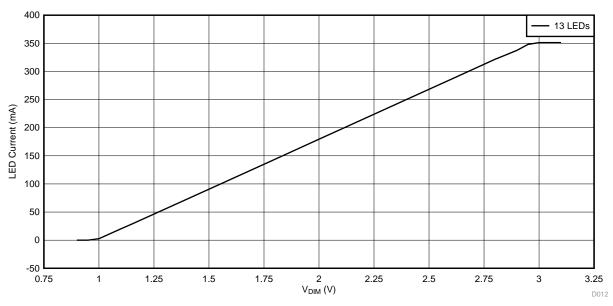
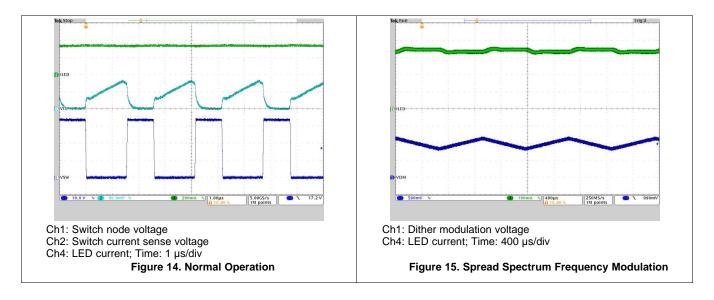


Figure 13. LED Current vs DIM/PWM Voltage (V_{IADJ} = 1.49 V, Number of LEDs in Series = 13)

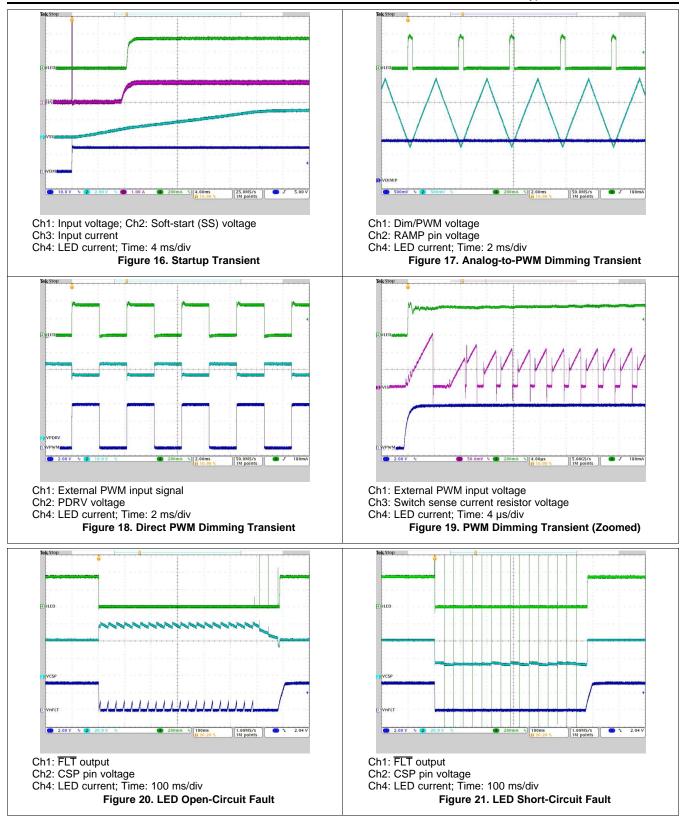
6.7 Direct External PWM Dimming

The EVM can be configured for direct PWM dimming based on an external signal by changing the shunt position and shorting pins 1 and 2 of J6 and pins 1 and 2 of J7. An external function generator can be connected to PWM test point, TP8 and the LED current can be directly modulated based on the duty cycle of external PWM signal.

6.8 Typical Waveforms









6.9 EMI

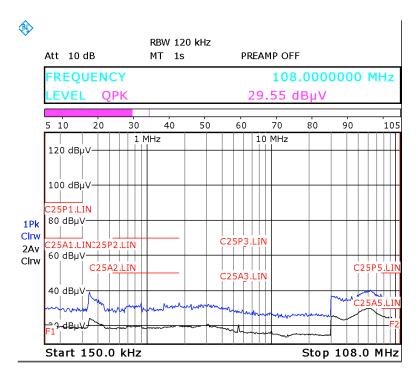


Figure 22. Conducted EMI Based on CISPR 25 Class 3 Limits (Dither Modulation Enabled)



7 Buck-Boost LED Driver Electrical Performance Specifications

Table 2 provides the EVM Buck-Boost configuration electrical performance specifications.

Table 2. TPS92692EVM-880 Buck-Boost Configuration Electrical Performance Specifications

Parameter	Test Conditions	MIN	TYP	MAX	Unit
Input Characteristics				<u>.</u>	
Input voltage range		7	14	18	V
Input UVLO setting			4.5		V
Maximum switch node voltage				100	V
Output Characteristics				•	
Output voltage, V _O	LED+ to VIN	3	21	39.6	V
LED current		100	350	500	mA
Maximum output power				20	W
Analog dimming range	V _{IADJ} = 140 mV to 2.1 V	15:1			
Internal RAMP generator frequency	Internal RAMP generator		240		Hz
Analog to PWM duty cycle set point (low brightness mode)			8		%
Analog to PWM duty cycle dimming range	1 ≤ V _{DIM} ≤ 3	4		100	%
Direct PWM dimming range	External PWM input signal, 100 ≤ f _{PWM} ≤ 1 kHz	1		100	%
Systems Characteristics				J.	
Output overvoltage protection threshold			44		V
Output overvoltage protection hysteresis			3		V
Soft-start period			8		ms
Dither modulation frequency			600		Hz
Switching frequency			390		kHz

8 Buck-Boost LED Driver Schematic

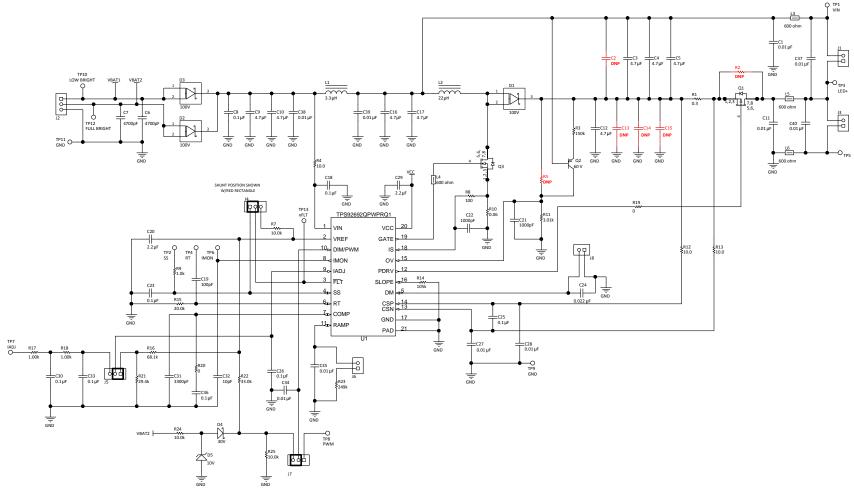


Figure 23. TPS92692EVM-880 Schematic: Configured as a Buck-Boost LED Driver



9 Performance Data and Typical Characteristic Curves

The following performance curves are presented for the EVM configured as a Buck-Boost LED driver (Figure 23).

9.1 Efficiency

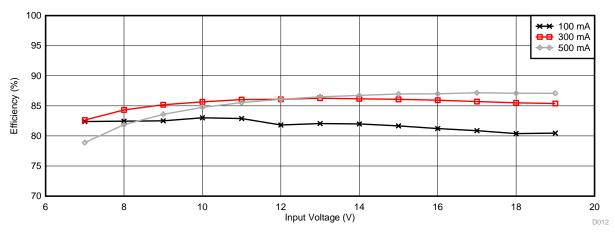


Figure 24. Efficiency vs Input Voltage (Number of Series-Connected LEDs = 7)

9.2 Line Regulation

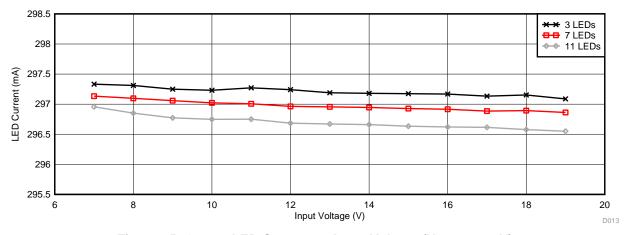


Figure 25. Output LED Current vs Input Voltage (V_{IADJ} = 1.26 V)



9.3 Load Regulation

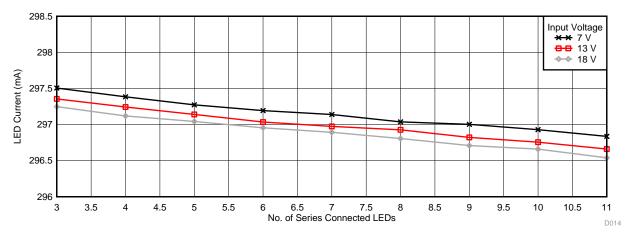
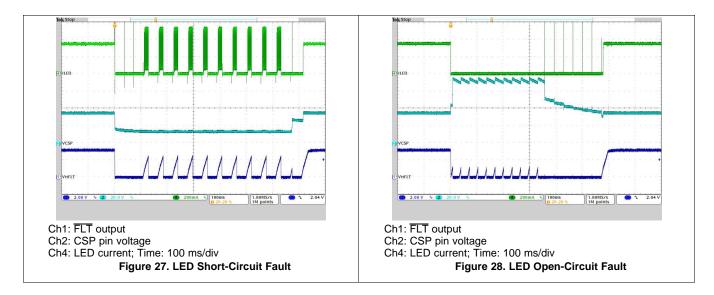


Figure 26. Output LED Current vs LED String Configuration ($V_{IADJ} = 1.26 \text{ V}$)

9.4 Typical Waveforms





10 TPS92692EVM-880 Assembly Drawing and PCB layout

Figure 29, Figure 30, and Figure 31 show the design and assembly of the TPS92692EVM-880 printed-circuit board.

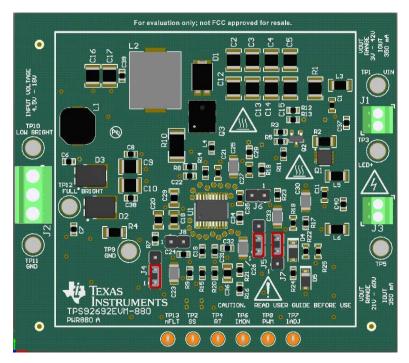


Figure 29. Assembly Drawing



Figure 30. Top Layer and Top Overlay (Top View)



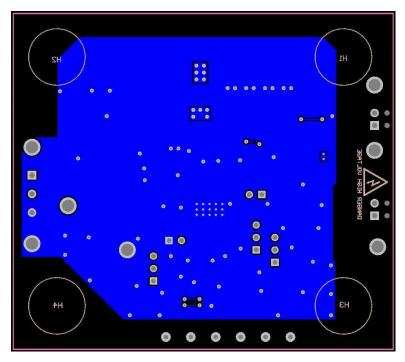


Figure 31. Bottom Layer and Bottom Overlay (Bottom View)



Bill of Materials www.ti.com

11 **Bill of Materials**

Table 3 lists the TPS92692EVM-880 components for Boost configuration according to the schematic shown in Figure 2.

Table 3. Bill of Materials

C38, C39, C40 0603 CAP, CERM, 4700 pF, 100 V, ±10%, X7R, AEC-Q200 Grade 1, 0603 CGA3E2X7F 0603 C8 1 0.1 uF CAP, CERM, 0.1 μF, 50 V, ±10%, X7R, AEC-Q200 Grade 1, 0603 0603 CGA3E2X7F 0603 C9, C10, C12, C13, C14, C15, C16, C17 8 4.7 uF CAP, CERM, 4.7 μF, 100 V, ±10%, X7S, AEC-Q200 Grade 1, 1210 1210 CGA6M3X7S 1210 C18 1 0.1 uF CAP, CERM, 0.1 μF, 100 V, ±10%, X7R, 0805 0805 C2012X7R2 C19 1 100 pF CAP, CERM, 100 pF, 100 V, ±1%, COG/NP0, 0603 0603 C1608C0G2 C20, C29 2 2.2 uF CAP, CERM, 100 pF, 100 V, ±10%, X7R, AEC-Q200 Grade 1, 0805 0805 CGA4J3X7R C21, C22 2 1000 pF CAP, CERM, 1000 pF, 100 V, ±10%, X7R, AEC-Q200 Grade 1, 0603 CGA3E2X7F C23, C25, C26, C30, C33 5 0.1 uF CAP, CERM, 0.1 μF, 100 V, ±10%, X7R, AEC-Q200 Grade 1, 1206 1206 CGA5L2X7R C31 1 0.022 uF CAP, CERM, 0.022 μF, 100 V, ±10%, X7R, AEC-Q200 Grade 1, 0603 GGA3E2X7F C32 1 10pF CAP, CERM, 3300 pF, 50 V, ±10%, X7R, 0603 0603 GRM188R71 C31 1 300 pF CAP, CERM, 10 pF, 50 V,	PWPRQ1 Texas Instruments R2A103K080AA TDK R2A472K080AA TDK R1H104K080AA TDK S2A475K200AB TDK 2A104K125AA TDK 2A101F080AA TDK R1E225K125AB TDK R2A102K080AA TDK
C38, C39, C40 0603 CGAP, CERM, 4700 pF, 100 V, ±10%, X7R, AEC-Q200 Grade 1, 0603 CGA3E2X7F 0603 C8 1 0.1uF CAP, CERM, 0.1 μF, 50 V, ±10%, X7R, AEC-Q200 Grade 1, 0603 0603 CGA3E2X7F 0603 C9, C10, C12, C13, C14, C15, C14, C15, C16, C17 8 4.7uF CAP, CERM, 4.7 μF, 100 V, ±10%, X7S, AEC-Q200 Grade 1, 1210 1210 CGA6M3X7S 1210 C18 1 0.1uF CAP, CERM, 0.1 μF, 100 V, ±10%, X7R, 0805 0805 C2012X7R2 C19 1 100pF CAP, CERM, 100 pF, 100 V, ±1%, C0G/NP0, 0603 0603 C1608C0G2 C20, C29 2 2.2uF CAP, CERM, 100 pF, 100 V, ±10%, X7R, AEC-Q200 Grade 1, 0805 0805 CGA4J3X7R C21, C22 2 1000pF CAP, CERM, 1000 pF, 100 V, ±10%, X7R, AEC-Q200 Grade 1, 0603 CGA3E2X7F C23, C25, C26, C30, C33 5 0.1uF CAP, CERM, 0.1 μF, 100 V, ±10%, X7R, AEC-Q200 Grade 1, 1206 1206 CGA5E2X7F C31 1 3300pF CAP, CERM, 3300 pF, 50 V, ±10%, X7R, AEC-Q200 Grade 1, 0603 0603 GRM188R71 C32 1 10pF CAP, CERM, 10 pF, 50 V, ±5%, COG/NPO, AEC-Q200 Grade 1, 0603 0603<	R2A472K080AA TDK R1H104K080AA TDK S2A475K200AB TDK 2A104K125AA TDK 2A101F080AA TDK R1E225K125AB TDK
C8	R1H104K080AA TDK S2A475K200AB TDK PA104K125AA TDK PA101F080AA TDK R1E225K125AB TDK
C9, C10, C12, C13, C14, C15, C17 C15, C16, C17 C18 C19 C19 C19 C19 C19 C19 C19	ZS2A475K200AB TDK ZA104K125AA TDK ZA101F080AA TDK R1E225K125AB TDK
C15, C16, C17 1210 1210 C18 1 0.1 uF CAP, CERM, 0.1 μF, 100 V, ±10%, X7R, 0805 0805 C2012X7R2/CD C19 1 100pF CAP, CERM, 100 pF, 100 V, ±1%, C0G/NP0, 0603 0603 C1608C0G2 C20, C29 2 2.2 uF CAP, CERM, 100 pF, 100 V, ±10%, X7R, AEC-Q200 Grade 1, 0805 0805 CGA4J3X7R C21, C22 2 1000pF CAP, CERM, 1000 pF, 100 V, ±10%, X7R, AEC-Q200 Grade 1, 0603 0603 CGA3E2X7R C23, C25, C26, C30, C33 5 0.1 uF CAP, CERM, 0.1 μF, 100 V, ±10%, X7R, AEC-Q200 Grade 1, 1206 1206 CGA5L2X7R C24 1 0.022uF CAP, CERM, 0.022 μF, 100 V, ±10%, X7R, AEC-Q200 Grade 1, 0603 0603 CGA3E2X7R C31 1 3300pF CAP, CERM, 3300 pF, 50 V, ±10%, X7R, 0603 0603 GRM188R71 C32 1 10pF CAP, CERM, 10 pF, 50 V, ±5%, C0G/NP0, AEC-Q200 Grade 1, 0603 0603 CGA3E2C0C C36 1 0.1 uF CAP, CERM, 0.1 μF, 50 V, ±10%, X7R, AEC-Q200 Grade 1, 0805 0805 CEU4J2X7R D1 1 100V Diode, Schottky, 100 V, 3 A, AEC-Q101, PowerDI5 PowerDI5 PDS3100Q-7	2A104K125AA TDK 2A101F080AA TDK R1E225K125AB TDK
C19 1 100pF CAP, CERM, 100 pF, 100 V, ±1%, COG/NP0, 0603 0603 C1608COG2 C20, C29 2 2.2uF CAP, CERM, 2.2 μF, 25 V, ±10%, X7R, AEC-Q200 Grade 1, 0805 0805 CGA4J3X7R C21, C22 2 1000pF CAP, CERM, 1000 pF, 100 V, ±10%, X7R, AEC-Q200 Grade 1, 0603 0603 CGA3E2X7F C23, C25, C26, C30, C33 5 0.1uF CAP, CERM, 0.1 μF, 100 V, ±10%, X7R, AEC-Q200 Grade 1, 1206 1206 CGA5L2X7R C24 1 0.022uF CAP, CERM, 0.022 μF, 100 V, ±10%, X7R, AEC-Q200 Grade 1, 0603 0603 CGA3E2X7F C31 1 3300pF CAP, CERM, 3300 pF, 50 V, ±10%, X7R, 0603 0603 GRM188R71 C32 1 10pF CAP, CERM, 10 pF, 50 V, ±5%, C0G/NP0, AEC-Q200 Grade 1, 0603 0603 CGA3E2C00 C36 1 0.1uF CAP, CERM, 0.1 μF, 50 V, ±10%, X7R, AEC-Q200 Grade 1, 0805 0805 CEU4J2X7R D1 1 100V Diode, Schottky, 100 V, 3 A, AEC-Q101, PowerDI5 PowerDI5 PDS3100Q-7	2A101F080AA TDK R1E225K125AB TDK
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C21, C22 2 1000pF CAP, CERM, 1000 pF, 100 V, ±10%, X7R, AEC-Q200 Grade 1, 0603 0603 CGA3E2X7F C23, C25, C26, C30, C33 5 0.1uF CAP, CERM, 0.1 μF, 100 V, ±10%, X7R, AEC-Q200 Grade 1, 1206 1206 CGA5L2X7R C24 1 0.022uF CAP, CERM, 0.022 μF, 100 V, ±10%, X7R, AEC-Q200 Grade 1, 0603 0603 CGA3E2X7F C31 1 3300pF CAP, CERM, 3300 pF, 50 V, ±10%, X7R, 0603 0603 GRM188R71 C32 1 10pF CAP, CERM, 10 pF, 50 V, ±5%, C0G/NP0, AEC-Q200 Grade 1, 0603 0603 CGA3E2C0C C36 1 0.1uF CAP, CERM, 0.1 μF, 50 V, ±10%, X7R, AEC-Q200 Grade 1, 0805 0805 CEU4J2X7R D1 1 100V Diode, Schottky, 100 V, 3 A, AEC-Q101, PowerDI5 PowerDI5 PDS3100Q-7	
C23, C25, C26, C30, C33 5 0.1 uF CAP, CERM, 0.1 μF, 100 V, ±10%, X7R, AEC-Q200 Grade 1, 1206 CGA5L2X7R	R2A102K080AA TDK
C24 1 0.022uF CAP, CERM, 0.022 μF, 100 V, ±10%, X7R, AEC-Q200 Grade 1, 0603 0603 CGA3E2X7F C31 1 3300pF CAP, CERM, 3300 pF, 50 V, ±10%, X7R, 0603 0603 GRM188R71 C32 1 10pF CAP, CERM, 10 pF, 50 V, ±5%, COG/NPO, AEC-Q200 Grade 1, 0603 0603 CGA3E2COG C36 1 0.1uF CAP, CERM, 0.1 μF, 50 V, ±10%, X7R, AEC-Q200 Grade 1, 0805 0805 CEU4J2X7R D1 1 100V Diode, Schottky, 100 V, 3 A, AEC-Q101, PowerDI5 PowerDI5 PDS3100Q-7	
C31 1 3300pF CAP, CERM, 3300 pF, 50 V, ±10%, X7R, 0603 0603 GRM188R71 C32 1 10pF CAP, CERM, 10 pF, 50 V, ±5%, COG/NP0, AEC-Q200 Grade 1, 0603 0603 CGA3E2C00 C36 1 0.1uF CAP, CERM, 0.1 μF, 50 V, ±10%, X7R, AEC-Q200 Grade 1, 0805 0805 CEU4J2X7R D1 1 100V Diode, Schottky, 100 V, 3 A, AEC-Q101, PowerDI5 PowerDI5 PDS3100Q-7	R2A104K160AA TDK
C32 1 10pF CAP, CERM, 10 pF, 50 V, ±5%, COG/NP0, AEC-Q200 Grade 1, 0603 CGA3E2COC Grade 1 0.1 0.1 CAP, CERM, 0.1 μF, 50 V, ±10%, X7R, AEC-Q200 Grade 1, 0805 CEU4J2X7R D1 1 100V Diode, Schottky, 100 V, 3 A, AEC-Q101, PowerDI5 PowerDI5 PDS3100Q-7	R2A223K080AA TDK
C36 1 0.1uF CAP, CERM, 0.1 μF, 50 V, ±10%, X7R, AEC-Q200 Grade 1, 0805 0805 CEU4J2X7R D1 1 100V Diode, Schottky, 100 V, 3 A, AEC-Q101, PowerDI5 PowerDI5 PDS3100Q-7	1H332KA01D Murata
D1 1 100V Diode, Schottky, 100 V, 3 A, AEC-Q101, PowerDI5 PowerDI5 PowerDI5	G1H100D080AA TDK
11,111,111,111,111,111,111	R1H104K125AE TDK
	-13 Diodes Inc.
D2, D3 2 100V Diode, Schottky, 100 V, 12 A, AEC-Q101, TO-277A TO-277A V12P10-M3//	/86A Vishay-Semiconductor
D4 1 30V Diode, Schottky, 30 V, 0.2 A, SOD-123 SOD-123 BAT42W-7-F	F Diodes Inc.
D5 1 10V Diode, Zener, 10 V, 500 mW, SOD-123 SOD-123 MMSZ5240E	B-7-F Diodes Inc.
J1, J3 2 Terminal Block, 100mil, 2x1, 6A, 63V, TH 6.2x8.5x5.54 mm 1725656	Phoenix Contact
J2 1 Terminal Block Receptacle, 3x1, 3.81mm, R/A, TH Term Block, 3 pos 1727023	Phoenix Contact
J4, J5, J7 3 Header, 2.54mm, 3x1, Tin, TH 3x1, TH 0022284033	3 Molex
J6, J8 2 Header, 2.54mm, 2x1, Tin, TH 2x1, TH 0022284023	3 Molex
L1 1 3.3uH Inductor, Shielded, Ferrite, 3.3 μH, 5 A, 0.0213 ohm, SMD 6.2x4.5x5.9mm CLF7045T-3	3R3N TDK
L2 1 22uH Inductor, Shielded Drum Core, Powdered Iron, 22 μH, 4.1 A, 0.0705 ohm, AEC-Q200 Grade 0, SMD IHLP-4040DZ IHLP-4040DZ	ZER220M8A Vishay-Dale
L3, L5, L6 3 600 ohm Ferrite Bead, 600 ohm @ 100 MHz, 1.5 A, 1206 1206 MI1206K601	1R-10 Laird-Signal Integrity Products
L4 1 600 ohm Ferrite Bead, 600 ohm @ 100 MHz, 1.3 A, 0603 0603 BLM18KG60	01SN1D Murata



Bill of Materials www.ti.com

Table 3. Bill of Materials (continued)

Designator	Qty	Value	Description	Package	Part Number	Manufacturer
Q1	1	-60V	MOSFET, P-CH, -60 V, -3.6 A, PowerPAK 1212	PowerPAK 1212	SI7415DN-T1-GE3	Vishay-Siliconix
Q3	1	100V	MOSFET, N-CH, 100 V, 20 A, AEC-Q101, 8-PowerVDFN	8-PowerVDFN	STL8N10LF3	STMicroelectronics
R1	1	0.3	RES, 0.3, 1%, 0.5 W, 1210	1210	MCR25JZHFLR300	Rohm
R3, R5	2	150k	RES, 150 k, 1%, 0.1 W, 0603	0603	CRCW0603150KFKEA	Vishay-Dale
R4	1	10.0	RES, 10.0, 1%, 0.25 W, 1206	1206	CRCW120610R0FKEA	Vishay-Dale
R7, R24, R25	3	10.0k	RES, 10.0 k, 1%, 0.1 W, 0603	0603	CRCW060310K0FKEA	Vishay-Dale
R8	1	100	RES, 100, 1%, 0.1 W, 0603	0603	CRCW0603100RFKEA	Vishay-Dale
R9	1	1.0k	RES, 1.0 k, 5%, 0.1 W, 0603	0603	CRCW06031K00JNEA	Vishay-Dale
R10	1	0.06	RES, 0.06, 1%, 1 W, 2010	2010	CSRN2010FK60L0	Stackpole Electronics Inc
R11	1	3.01k	RES, 3.01 k, 1%, 0.1 W, 0603	0603	CRCW06033K01FKEA	Vishay-Dale
R12, R13	2	10.0	RES, 10.0, 1%, 0.1 W, 0603	0603	CRCW060310R0FKEA	Vishay-Dale
R14	1	105k	RES, 105 k, 1%, 0.1 W, 0603	0603	CRCW0603105KFKEA	Vishay-Dale
R15	1	20.0k	RES, 20.0 k, 1%, 0.1 W, 0603	0603	CRCW060320K0FKEA	Vishay-Dale
R16	1	68.1k	RES, 68.1 k, 1%, 0.1 W, 0603	0603	CRCW060368K1FKEA	Vishay-Dale
R17, R18	2	1.00k	RES, 1.00 k, 1%, 0.1 W, 0603	0603	CRCW06031K00FKEA	Vishay-Dale
R19, R20	2	0	RES, 0, 5%, 0.1 W, 0603	0603	CRCW06030000Z0EA	Vishay-Dale
R21	1	29.4k	RES, 29.4 k, 1%, 0.1 W, 0603	0603	CRCW060329K4FKEA	Vishay-Dale
R22	1	33.0k	RES, 33.0 k, 1%, 0.1 W, 0603	0603	CRCW060333K0FKEA	Vishay-Dale
R23	1	249k	RES, 249 k, 1%, 0.1 W, 0603	0603	CRCW0603249KFKEA	Vishay-Dale

STANDARD TERMS FOR EVALUATION MODULES

- 1. Delivery: TI delivers TI evaluation boards, kits, or modules, including any accompanying demonstration software, components, and/or documentation which may be provided together or separately (collectively, an "EVM" or "EVMs") to the User ("User") in accordance with the terms set forth herein. User's acceptance of the EVM is expressly subject to the following terms.
 - 1.1 EVMs are intended solely for product or software developers for use in a research and development setting to facilitate feasibility evaluation, experimentation, or scientific analysis of TI semiconductors products. EVMs have no direct function and are not finished products. EVMs shall not be directly or indirectly assembled as a part or subassembly in any finished product. For clarification, any software or software tools provided with the EVM ("Software") shall not be subject to the terms and conditions set forth herein but rather shall be subject to the applicable terms that accompany such Software
 - 1.2 EVMs are not intended for consumer or household use. EVMs may not be sold, sublicensed, leased, rented, loaned, assigned, or otherwise distributed for commercial purposes by Users, in whole or in part, or used in any finished product or production system.
- 2 Limited Warranty and Related Remedies/Disclaimers:
 - 2.1 These terms do not apply to Software. The warranty, if any, for Software is covered in the applicable Software License Agreement.
 - 2.2 TI warrants that the TI EVM will conform to TI's published specifications for ninety (90) days after the date TI delivers such EVM to User. Notwithstanding the foregoing, TI shall not be liable for a nonconforming EVM if (a) the nonconformity was caused by neglect, misuse or mistreatment by an entity other than TI, including improper installation or testing, or for any EVMs that have been altered or modified in any way by an entity other than TI, (b) the nonconformity resulted from User's design, specifications or instructions for such EVMs or improper system design, or (c) User has not paid on time. Testing and other quality control techniques are used to the extent TI deems necessary. TI does not test all parameters of each EVM. User's claims against TI under this Section 2 are void if User fails to notify TI of any apparent defects in the EVMs within ten (10) business days after the defect has been detected.
 - 2.3 Tl's sole liability shall be at its option to repair or replace EVMs that fail to conform to the warranty set forth above, or credit User's account for such EVM. Tl's liability under this warranty shall be limited to EVMs that are returned during the warranty period to the address designated by Tl and that are determined by Tl not to conform to such warranty. If Tl elects to repair or replace such EVM, Tl shall have a reasonable time to repair such EVM or provide replacements. Repaired EVMs shall be warranted for the remainder of the original warranty period. Replaced EVMs shall be warranted for a new full ninety (90) day warranty period.
- 3 Regulatory Notices:
 - 3.1 United States
 - 3.1.1 Notice applicable to EVMs not FCC-Approved:

FCC NOTICE: This kit is designed to allow product developers to evaluate electronic components, circuitry, or software associated with the kit to determine whether to incorporate such items in a finished product and software developers to write software applications for use with the end product. This kit is not a finished product and when assembled may not be resold or otherwise marketed unless all required FCC equipment authorizations are first obtained. Operation is subject to the condition that this product not cause harmful interference to licensed radio stations and that this product accept harmful interference. Unless the assembled kit is designed to operate under part 15, part 18 or part 95 of this chapter, the operator of the kit must operate under the authority of an FCC license holder or must secure an experimental authorization under part 5 of this chapter.

3.1.2 For EVMs annotated as FCC - FEDERAL COMMUNICATIONS COMMISSION Part 15 Compliant:

CAUTION

This device complies with part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) This device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.

Changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

FCC Interference Statement for Class A EVM devices

NOTE: This equipment has been tested and found to comply with the limits for a Class A digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference when the equipment is operated in a commercial environment. This equipment generates, uses, and can radiate radio frequency energy and, if not installed and used in accordance with the instruction manual, may cause harmful interference to radio communications. Operation of this equipment in a residential area is likely to cause harmful interference in which case the user will be required to correct the interference at his own expense.

FCC Interference Statement for Class B EVM devices

NOTE: This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

- Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and receiver.
- · Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- Consult the dealer or an experienced radio/TV technician for help.

3.2 Canada

3.2.1 For EVMs issued with an Industry Canada Certificate of Conformance to RSS-210 or RSS-247

Concerning EVMs Including Radio Transmitters:

This device complies with Industry Canada license-exempt RSSs. Operation is subject to the following two conditions:

(1) this device may not cause interference, and (2) this device must accept any interference, including interference that may cause undesired operation of the device.

Concernant les EVMs avec appareils radio:

Le présent appareil est conforme aux CNR d'Industrie Canada applicables aux appareils radio exempts de licence. L'exploitation est autorisée aux deux conditions suivantes: (1) l'appareil ne doit pas produire de brouillage, et (2) l'utilisateur de l'appareil doit accepter tout brouillage radioélectrique subi, même si le brouillage est susceptible d'en compromettre le fonctionnement.

Concerning EVMs Including Detachable Antennas:

Under Industry Canada regulations, this radio transmitter may only operate using an antenna of a type and maximum (or lesser) gain approved for the transmitter by Industry Canada. To reduce potential radio interference to other users, the antenna type and its gain should be so chosen that the equivalent isotropically radiated power (e.i.r.p.) is not more than that necessary for successful communication. This radio transmitter has been approved by Industry Canada to operate with the antenna types listed in the user guide with the maximum permissible gain and required antenna impedance for each antenna type indicated. Antenna types not included in this list, having a gain greater than the maximum gain indicated for that type, are strictly prohibited for use with this device.

Concernant les EVMs avec antennes détachables

Conformément à la réglementation d'Industrie Canada, le présent émetteur radio peut fonctionner avec une antenne d'un type et d'un gain maximal (ou inférieur) approuvé pour l'émetteur par Industrie Canada. Dans le but de réduire les risques de brouillage radioélectrique à l'intention des autres utilisateurs, il faut choisir le type d'antenne et son gain de sorte que la puissance isotrope rayonnée équivalente (p.i.r.e.) ne dépasse pas l'intensité nécessaire à l'établissement d'une communication satisfaisante. Le présent émetteur radio a été approuvé par Industrie Canada pour fonctionner avec les types d'antenne énumérés dans le manuel d'usage et ayant un gain admissible maximal et l'impédance requise pour chaque type d'antenne. Les types d'antenne non inclus dans cette liste, ou dont le gain est supérieur au gain maximal indiqué, sont strictement interdits pour l'exploitation de l'émetteur

3.3 Japan

- 3.3.1 Notice for EVMs delivered in Japan: Please see http://www.tij.co.jp/lsds/ti_ja/general/eStore/notice_01.page 日本国内に輸入される評価用キット、ボードについては、次のところをご覧ください。
 http://www.tij.co.jp/lsds/ti_ja/general/eStore/notice_01.page
- 3.3.2 Notice for Users of EVMs Considered "Radio Frequency Products" in Japan: EVMs entering Japan may not be certified by TI as conforming to Technical Regulations of Radio Law of Japan.

If User uses EVMs in Japan, not certified to Technical Regulations of Radio Law of Japan, User is required to follow the instructions set forth by Radio Law of Japan, which includes, but is not limited to, the instructions below with respect to EVMs (which for the avoidance of doubt are stated strictly for convenience and should be verified by User):

- 1. Use EVMs in a shielded room or any other test facility as defined in the notification #173 issued by Ministry of Internal Affairs and Communications on March 28, 2006, based on Sub-section 1.1 of Article 6 of the Ministry's Rule for Enforcement of Radio Law of Japan,
- 2. Use EVMs only after User obtains the license of Test Radio Station as provided in Radio Law of Japan with respect to EVMs, or
- 3. Use of EVMs only after User obtains the Technical Regulations Conformity Certification as provided in Radio Law of Japan with respect to EVMs. Also, do not transfer EVMs, unless User gives the same notice above to the transferee. Please note that if User does not follow the instructions above, User will be subject to penalties of Radio Law of Japan.

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- 3. 技術基準適合証明を取得後ご使用いただく。
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3.3.3 Notice for EVMs for Power Line Communication: Please see http://www.tij.co.jp/lsds/ti_ja/general/eStore/notice_02.page 電力線搬送波通信についての開発キットをお使いになる際の注意事項については、次のところをご覧ください。http://www.tij.co.jp/lsds/ti_ja/general/eStore/notice_02.page

3.4 European Union

3.4.1 For EVMs subject to EU Directive 2014/30/EU (Electromagnetic Compatibility Directive):

This is a class A product intended for use in environments other than domestic environments that are connected to a low-voltage power-supply network that supplies buildings used for domestic purposes. In a domestic environment this product may cause radio interference in which case the user may be required to take adequate measures.

- 4 EVM Use Restrictions and Warnings:
 - 4.1 EVMS ARE NOT FOR USE IN FUNCTIONAL SAFETY AND/OR SAFETY CRITICAL EVALUATIONS, INCLUDING BUT NOT LIMITED TO EVALUATIONS OF LIFE SUPPORT APPLICATIONS.
 - 4.2 User must read and apply the user guide and other available documentation provided by TI regarding the EVM prior to handling or using the EVM, including without limitation any warning or restriction notices. The notices contain important safety information related to, for example, temperatures and voltages.
 - 4.3 Safety-Related Warnings and Restrictions:
 - 4.3.1 User shall operate the EVM within TI's recommended specifications and environmental considerations stated in the user guide, other available documentation provided by TI, and any other applicable requirements and employ reasonable and customary safeguards. Exceeding the specified performance ratings and specifications (including but not limited to input and output voltage, current, power, and environmental ranges) for the EVM may cause personal injury or death, or property damage. If there are questions concerning performance ratings and specifications, User should contact a TI field representative prior to connecting interface electronics including input power and intended loads. Any loads applied outside of the specified output range may also result in unintended and/or inaccurate operation and/or possible permanent damage to the EVM and/or interface electronics. Please consult the EVM user guide prior to connecting any load to the EVM output. If there is uncertainty as to the load specification, please contact a TI field representative. During normal operation, even with the inputs and outputs kept within the specified allowable ranges, some circuit components may have elevated case temperatures. These components include but are not limited to linear regulators, switching transistors, pass transistors, current sense resistors, and heat sinks, which can be identified using the information in the associated documentation. When working with the EVM, please be aware that the EVM may become very warm.
 - 4.3.2 EVMs are intended solely for use by technically qualified, professional electronics experts who are familiar with the dangers and application risks associated with handling electrical mechanical components, systems, and subsystems. User assumes all responsibility and liability for proper and safe handling and use of the EVM by User or its employees, affiliates, contractors or designees. User assumes all responsibility and liability to ensure that any interfaces (electronic and/or mechanical) between the EVM and any human body are designed with suitable isolation and means to safely limit accessible leakage currents to minimize the risk of electrical shock hazard. User assumes all responsibility and liability for any improper or unsafe handling or use of the EVM by User or its employees, affiliates, contractors or designees.
 - 4.4 User assumes all responsibility and liability to determine whether the EVM is subject to any applicable international, federal, state, or local laws and regulations related to User's handling and use of the EVM and, if applicable, User assumes all responsibility and liability for compliance in all respects with such laws and regulations. User assumes all responsibility and liability for proper disposal and recycling of the EVM consistent with all applicable international, federal, state, and local requirements.
- 5. Accuracy of Information: To the extent TI provides information on the availability and function of EVMs, TI attempts to be as accurate as possible. However, TI does not warrant the accuracy of EVM descriptions, EVM availability or other information on its websites as accurate, complete, reliable, current, or error-free.

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